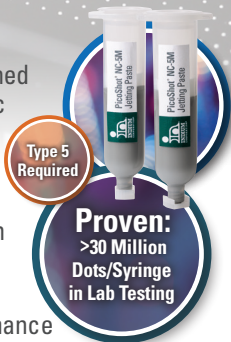


Jetting Paste

# PicoShot® NC-5M

**Mycronic Approved**

- Jetting solder paste designed and approved for Mycronic MY600 and MY700 jetting systems
  - Standard metal load: 85%
- No-clean solder paste with **identical flux chemistry to Indium8.9HF Solder Paste**
- Exceptional jetting performance for halogen-free and lead-free paste
  - Consistent precision deposition (x, y) targeting
  - Jetting life (syringe) >8 hours
- Reduces head-in-pillow (HIP) defects
- Eliminates or significantly reduces graping
- Minimizes reflow spatter



Contact our engineers: [askus@indium.com](mailto:askus@indium.com)  
Learn more: [www.indium.com/jetting-paste](http://www.indium.com/jetting-paste)

*All of Indium Corporation's solder paste and preform manufacturing facilities are IATF 16949:2016 certified.  
Indium Corporation is an ISO 9001:2015 registered company.*

# Jetting and Microdispensing Paste **Indium12.8HF**

## Versatile Paste for Various Systems

- Engineered to fit into a variety of jetting and microdispense systems
  - Flexible metal load (78-85%) to provide optimal dispensability
  - Fine-powder adaptability: Type 5–8 powder size
- Exceptional jetting and microdispensing performance for halogen-free and lead-free paste
  - Proven: Smooth, fast dispense
- No-clean solder paste with **identical flux chemistry to Indium8.9HF Solder Paste**



Recommended  
Type 6

**Proven:  
Advanced  
Performance**



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